

Professional high-speed optical transceiver

OPN-XS1312-10LC

1330 nm TX / 1270 nm RX , 8.5Gbps 1-Fiber Single-Mode LC XFP Transceiver

PRODUCT FEATURES

- 1-Fiber Bi-Directional XFP Optical Transceiver
 - Up to 8.5 Gbps Bi-directional Data Links
 - Complaint with XFP MSA
 - Compliant with 8G FC-BX
 - Compliant with 4G and 2G Fibre Channel
 - SFF-8472 Digital Diagnostic Function
 - Simplex LC Connector
 - 1330 nm DFB LD Transmitter
 - 1270 nm Receiver
 - Distance up to 10km
- 2-Wire Interface for Integrated Digital Diagnostic Monitoring
 - XFI Loopback Mode
 - No reference Clock required
- Only Required +3.3 V Power Supply
 - Power Consumption < 2 W
 - RoHS Compliant
- 0 to 70°C Operating : OPN-XS1312-10LC

APPLICATIONS

- 8G Fibre Channel Links

PRODUCT DESCRIPTION

OPN-XS1312-10LC series transceivers are single-mode transceiver for bi-directional serial optical data communications such as 8x/4x/2x FC-BX by using 1330 nm transmitter and 1270 nm receiver.

The transceiver consists of two sections: The transmitter section consists of a directly modulated 1330 nm DFB laser and is a class 1 laser compliant according to International Safety Standard IEC 60825. The receiver section uses an integrated 1270nm detector preamplifier (IDP) mounted in an optical header and a limiting post-amplifier IC.

The module is with the XFP 30-pin connector to allow hot plug capability. Integrated Tx and Rx signal conditioners provide high jitter-tolerance for full XFI compliance and no external reference clock required. The internally ac coupled high speed serial I/O simplifies interfacing to external circuitry. Only single 3.3V power supply is needed. The optical output can be disabled by LVTTTL logic high-level input of TX_DIS. Loss of signal (RX_LOS) output is provided to indicate the loss of an input optical signal of receiver.

A serial EEPROM in the transceiver allows the user to access transceiver digital diagnostic monitoring and configuration data via the 2-wire XFP Management Interface. This interface uses a single address, A0h, with a memory map divided into a lower and upper area. Basic digital diagnostic data is held in the lower area while specific data is held in a series of tables in the high memory area.

ORDER INFORMATION

P/No.	Bit Rate (Gb/s)	FC-PI-4	Distance (km)	TX (nm)	RX (nm)	Package	Temp (°C)	RoHS Compliant
OPN-XS1312-10LC	8 / 4 / 2	BX	10	1330 DFB	1270	LC XFP with DMI	0 to 70	Yes

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units	Notes
Storage Temperature	Tstg	-50	85	°C	
Operating Case Temperature	Topr	0	70	°C	OPN-XS1312-10LC
Relative Humidity	RH	0	85	%	Non condensing
Power Supply Voltage	Vcc3	0	3.6	V	

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Recommended Operating Conditions					
Parameter	Symbol	Min	Typ	Max	Units / Notes
Power Supply Voltage	V _{CC3}	3.13	3.3	3.47	V
Power Supply Current (@3.3V)	I _{CC3}			550	mA
Power Dissipation	P _D			2	W
Operating Case Temperature	T _{opr}	0		70	°C / OPN-XS1312-10LC
Data Rate			8.5		Gb/s

Transmitter Optical Specifications (T _{opr} = 0 to 70°C, V _{CC3} = 3.3V ±5%)						
Parameter	Symbol	Min	Typ	Max	Units	Notes
Average Launch Power	P _{O, Avg}	-5		0	dBm	1
Output Center Wavelength	λ _c	1320	1330	1340	nm	
Output Spectrum Width	σ _λ			1	nm	-20 dB width
Side Mode Suppression Ratio	SMSR	30			dB	
Relative Intensity Noise	RIN			-128	dB/Hz	
Optical Eye Mask	Compliant with IEEE 802.3ae 10GBASE-L XFP MSA					
Average Launch Power of OFF Transmitter				-30	dBm	

1. Output power is power coupled into a 9/125 μm single-mode fiber.

Receiver Optical Specifications (T _{opr} = 0 to 70°C, V _{CC3} = 3.3V ±5%)						
Parameter	Symbol	Min	Typ	Max	Units	Notes
Sensitivity @ 8.5Gb/s	SenI			-14	dBm	2, average received power
Receiver Overload	P _{MAX}	0.5	---		dBm	
LOS -- Deasserted	LOS _D	---	---	-18	dBm	Transition: low to high
LOS -- Asserted	LOS _A	-30	---	---	dBm	Transition: high to low
LOS -- Hysteresis		1	---	5	dB	
Wavelength of Operation	λ _c	1260		1280	nm	3

2. Measured with worst ER; BER < 10⁻¹² and PRBS 2⁷-1.

3. At least 30 dB optical isolation for the wavelength 1320 to 1340 nm.

Electrical Characteristics						
Parameter	Symbol	Min	Typ	Max	Units	Notes
High-Speed Signal (CML) Interface Specification						
Input Data Rate			8.5		Gb/s	
TX Clock Tolerance				±100	ppm	4
Differential Input Impedance	R _{in}		100		Ω	
Differential Data Input Amplitude		120		820	mVpp	5, Internally AC coupled
Output Data Rate			8.5		Gb/s	
RX Clock Tolerance				±100	ppm	4
Differential Output Impedance	R _{out}		100		Ω	
Differential Data Output Amplitude		340		850	mVpp	5, Internally AC coupled
Low-Speed Signal (LVTTTL) Interface Specification						
Input High Voltage		2.0		V _{CC}	V	
Input Low Voltage		GND		0.8	V	
Output High Voltage		2.4		V _{CC}	V	
Output Low Voltage		GND		0.5	V	
Reference Clock (LVPECL) Interface Specification						
No reference clock						

4. Clock tolerance for 8.5Gb/s, 4.25Gb/s, 2.12Gb/s, 1.063Gb/s and 1.25Gb/s.

5. The differential input and output amplitudes are per XFP MSA mask at points B' and C'.

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Transceiver Timing Characteristics						
Parameter	Symbol	Min	Typ	Max	Units	Notes
TX_DIS Assert Time	t _{off}			10	μs	
TX_DIS Negate Time	t _{on}			2	ms	
Time to Initialize	t _{init}			300	ms	
Interrupt Assert Delay	interrupt _{on}			200	ms	
Interrupt Negate Delay	interrupt _{off}			500	μs	
P_Down/PST Assert Delay	P_Down/RST _{on}			100	μs	
P_Down Nagate Delay	P_Down/RST _{off}			300	ms	
Mod_NR Assert Delay	Mod_nr _{on}			1	ms	
Mod_NR Negate Delay	Mod_nr _{off}			1	ms	
Mod_Desel Assert Time	T_Mod_Desel			2	ms	
Mod_Desel De-Assert Time	T_Mod_Sel			2	ms	
P_Down Reset Time	T _{reset}	10			μs	
RX_LOS Assert Delay	T_Los _{on}			100	μs	
RX_LOS Negate Delay	T_Los _{off}			100	μs	
Serial ID Clock Rate	f _{SCL}	0		400	kHz	

Management Interface

The structure of the memory map is shown in Figure 1, which is accessible over a 2-wire serial interface at the 8-bit address 1010000X (A0h). The normal 256 byte I2C address space is divided into low and upper blocks of 128 Bytes. The lower block of 128 Bytes is always directly available and is used for the diagnostics and control function. Multiple blocks of memories are available in the upper 128 Bytes of the address space. These are individually addressed through a table select Byte which the user enters into a location in the lower address space. Thus, there is a total available address space of 128*256 = 32 Kbytes in this upper memory space. The contents of Table 01h are listed in Table 1 below. Please refer SFF INF-8077i (Revision 4.5) for detailed information.

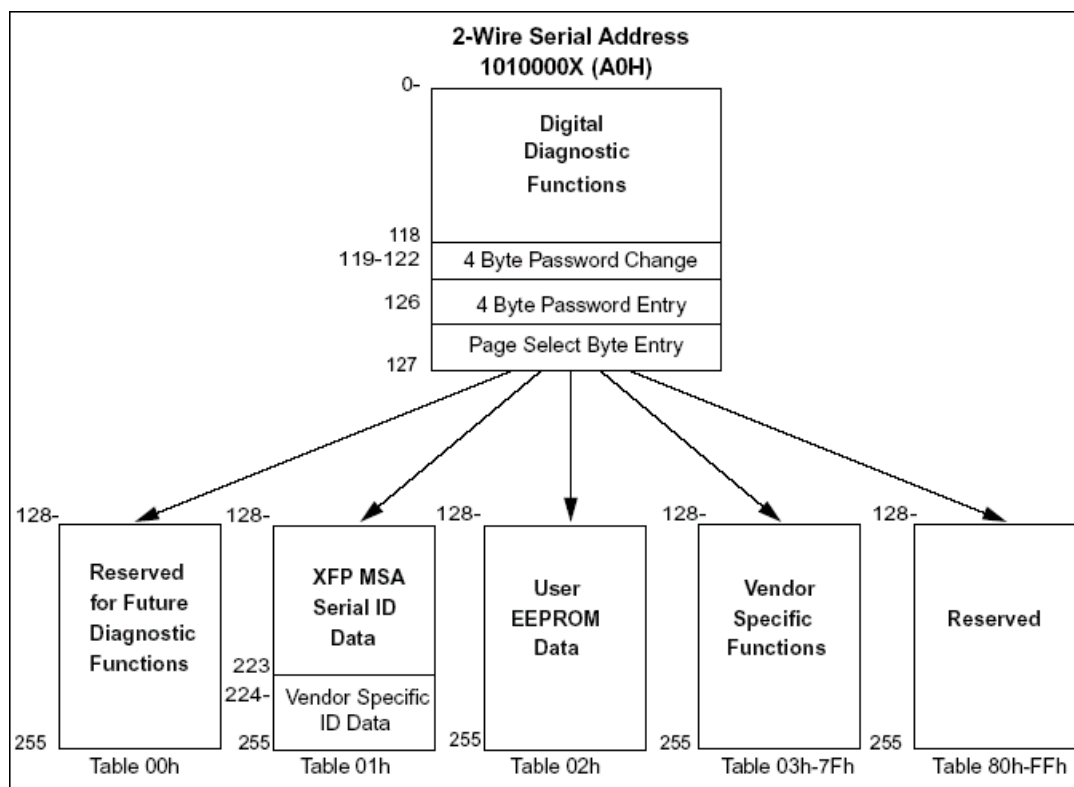


Figure 1. 2-wire Serial Digital Diagnostic Memory Map

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Table 1 Monitoring Specification

Data Address	Parameter	Accuracy
96 ~ 97	Temperature	± 3°C
98 ~ 99	Reserved	
100 ~ 101	Tx Bias	± 10%
102 ~ 103	Tx Power	± 2dB
104 ~ 105	Rx Power	± 2dB
106 ~ 107	Vcc3	± 3%

CONNECTION DIAGRAM

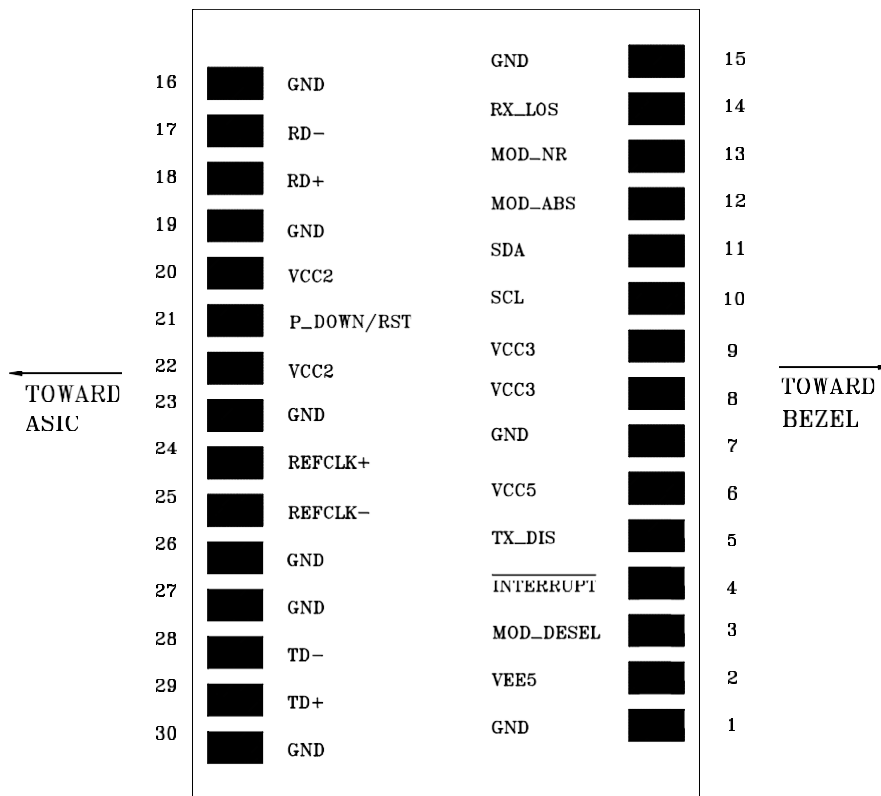


Table 3 PIN Description

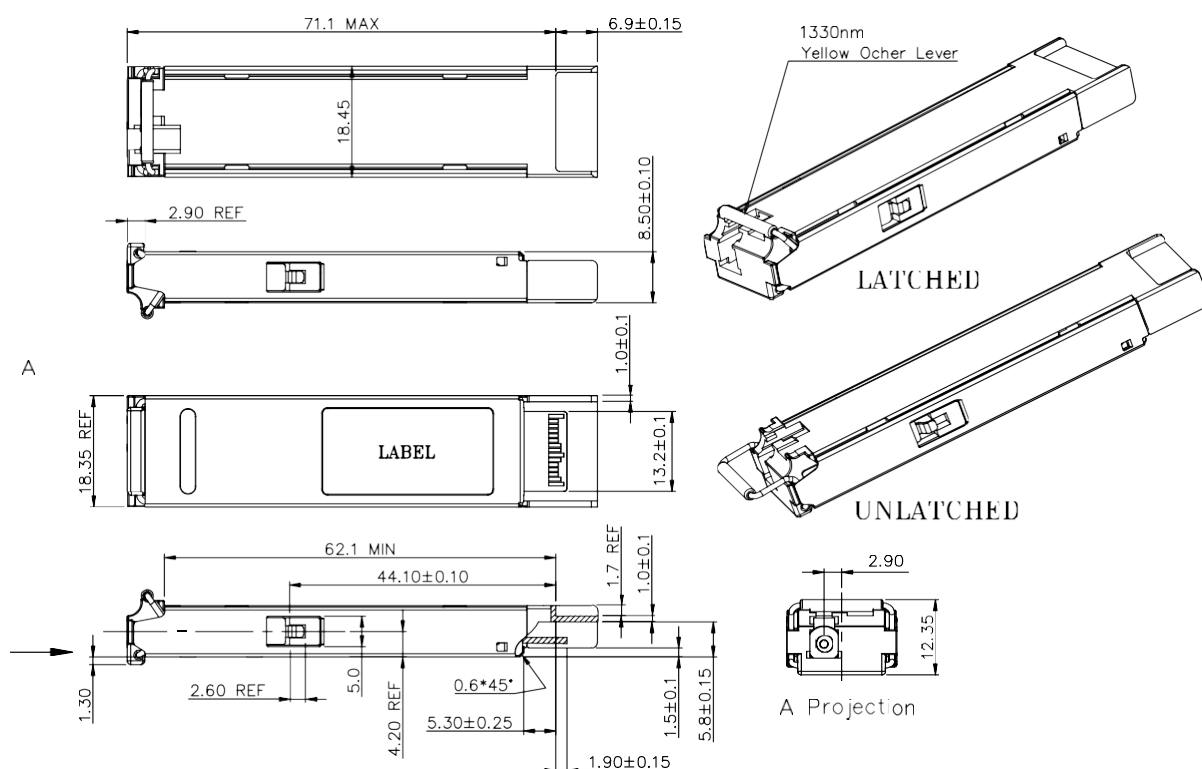
PIN	Logic	Signal Name	Description	Note
1		GND	Module Ground	1
2		VEE5	-5.2V Power Supply (Not required)	3
3	LVTTL-I	Mod_Desel	Module De-select; When held low allows module to respond to 2-wire serial interface	
4	LVTTL-O	Interrupt	Interrupt; Indicates presence of an important condition which can be read over the 2wire serial interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Turns off transmitter laser output	
6		VCC5	+5V Power Supply (Not required)	3
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I/O	SCL	Serial 2-wire interface clock	2
11	LVTTL-I/O	SDA	Serial 2-wire interface data line	2
12	LVTTL-O	Mod_Abs	Indicates Module is not present. Grounded in the Module	2
13	LVTTL-O	Mod_NR	Module Not Ready; Indicating Module Operational Fault	2
14	LVTTL-O	RX_LOS	Receiver Loss Of Signal Indicator	2
15		GND	Module Ground	1

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16		GND	Module Ground	1
17	CML-O	RD-	Receiver Inverted Data Output	
18	CML-O	RD+	Receiver Non-Inverted Data Output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply (Not required)	3
21	LVTTL-I	P_Down/RST	Power down; When high, requires the module to limit power consumption to 1.5W or below. 2-Wire serial interface must be functional in the low power mode. Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply (Not required)	3
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock Non-Inverted Input, AC coupled on the host board. (Not used. Internally terminated to 50 ohm (100 ohm diff.))	4
25	PECL-I	RefCLK-	Reference Clock Inverted Input, AC coupled on the host board. (Not used. Internally terminated to 50 ohm (100 ohm diff.))	4
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter Inverted Data Input	
29	CML-I	TD+	Transmitter Non-Inverted Data Input	
30		GND	Module Ground	1

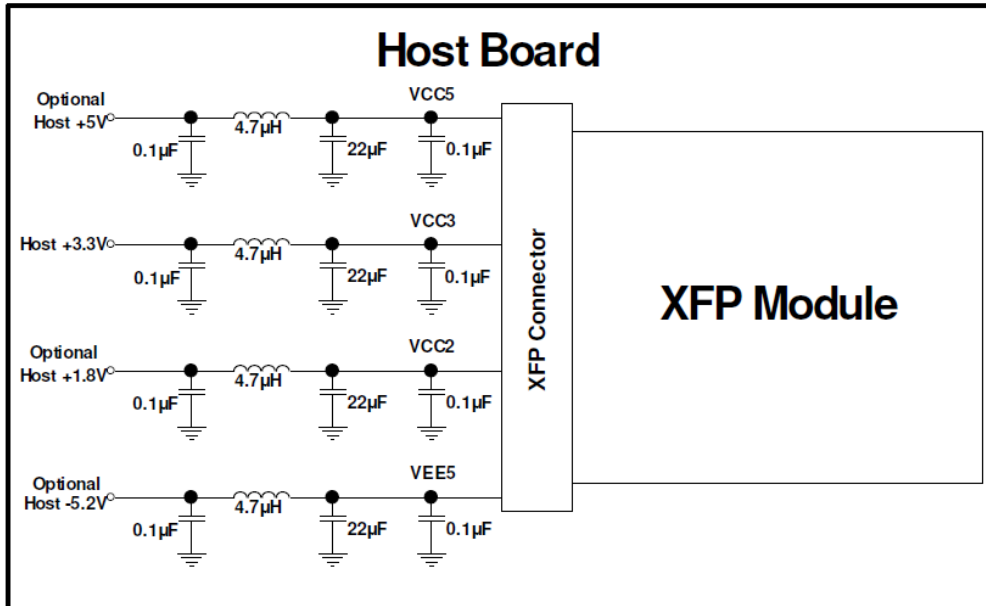
1. Module ground pins GND are isolated from the module case and chassis ground within the module.
2. Shall be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.45V on the host board.
3. These PINs are open within module.
4. A Reference Clock input is not required. If present, it will be ignored.

Mechanical Specification (Units in mm)



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Recommended Power Circuit Schematic



Recommended Interface Circuit

